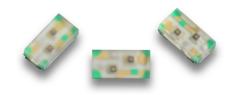


# APHB1608ZGSURKC

1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



# **DESCRIPTIONS**

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

# **FEATURES**

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- · Available in various color combination
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Tinned pads for improved solderability
- · Halogen-free
- RoHS compliant

# **APPLICATIONS**

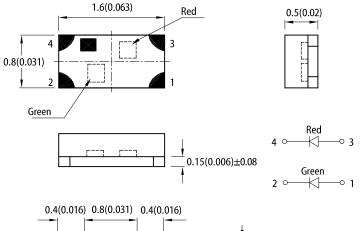
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

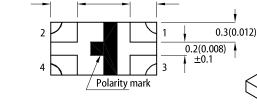
# **ATTENTION**

Observe precautions for handling electrostatic discharge sensitive devices

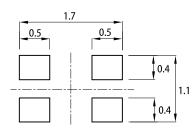


# **PACKAGE DIMENSIONS**









1. All dimensions are in millimeters (inches)

(units: mm; tolerance: ± 0.1)

- Tolerance is ±0.15(0.006") unless otherwise noted.
   The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

  The device has a single mounting surface. The device must be mounted according to the specifications

# **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APHB1608ZGSURKC	Green (InGaN)	Water Clear	200	400	130°
			*200	*400	
	■ Hyper Red (AlGalnP)		120	250	
			*40	*90	

1. 91/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value 2. Luminous intensity / luminous flux: +/-15%.

Luminous intensity value is traceable to CIE127-2007 standards.



# **ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

Donomotor	Symbol	Emitting Color	Va	Value	
Parameter			Тур.	Max.	Unit
Wavelength at Peak Emission I <sub>F</sub> = 20mA	$\lambda_{peak}$	Green Hyper Red	515 645	-	nm
Dominant Wavelength I <sub>F</sub> = 20mA	λ <sub>dom</sub> <sup>[1]</sup>	Green Hyper Red	525 630	-	nm
Spectral Bandwidth at 50% Φ REL MAX I <sub>F</sub> = 20mA	Δλ	Green Hyper Red	30 28	-	nm
Capacitance	С	Green Hyper Red	45 35	-	pF
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Green Hyper Red	3.3 1.95	4.1 2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Green Hyper Red	-	50 10	μA
Temperature Coefficient of $\lambda_{peak}$ I <sub>F</sub> = 20mA, -10° C ≤ T ≤ 85° C	TC <sub>λpeak</sub>	Green Hyper Red	0.05 0.14	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ I <sub>F</sub> = 20mA, -10° C ≤ T ≤ 85° C	TC <sub>λdom</sub>	Green Hyper Red	0.03 0.05	-	nm/°C
Temperature Coefficient of $V_F$ $I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>V</sub>	Green Hyper Red	-3.0 -1.9	-	mV/°C

# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Va	l lmi4		
Parameter	Symbol	Green	Hyper Red	Unit	
Power Dissipation	$P_{D}$	102.5	75	mW	
Reverse Voltage	$V_R$	5	5	V	
Junction Temperature	T <sub>j</sub>	115	115	°C	
Operating Temperature	T <sub>op</sub>	-40 to +85		°C	
Storage Temperature	T <sub>stg</sub>	-40 to +85		°C	
DC Forward Current	I <sub>F</sub>	25	30	mA	
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	150	185	mA	
Electrostatic Discharge Threshold (HBM)	-	450	3000	V	
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> [2]	630	640	°C/W	
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	450	490	°C/W	

Tules.

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

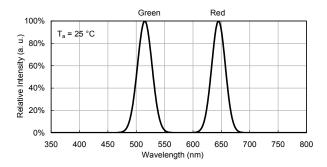


The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
 Forward voltage:±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

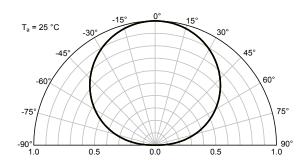


# **TECHNICAL DATA**

# **RELATIVE INTENSITY vs. WAVELENGTH**

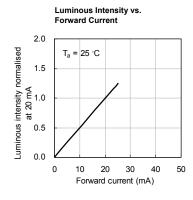


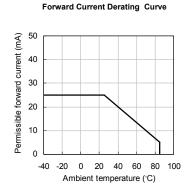
#### **SPATIAL DISTRIBUTION**

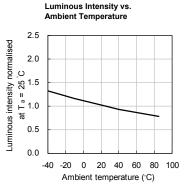


# **GREEN**

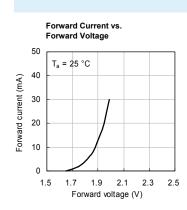
Forward Current vs. Forward Voltage T<sub>a</sub> = 25 °C 40 Forward current (mA) 30 20 10 0 2.0 3.0 3.5 4.0 Forward voltage (V)

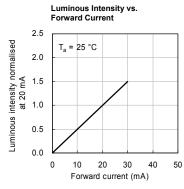


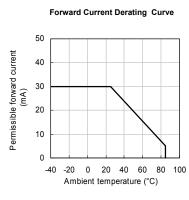


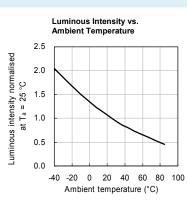


# **HYPER RED**







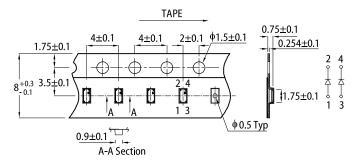




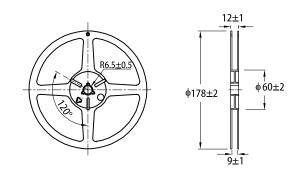
#### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**

#### 300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 25°C 50 100 150 200 250 300 Time

# TAPE SPECIFICATIONS (units:mm)



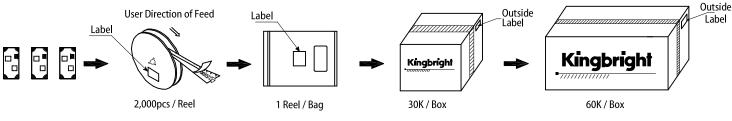
# **REEL DIMENSION** (units: mm)



#### Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
   Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

# **PACKING & LABEL SPECIFICATIONS**





# **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

  The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheef for the updated specifications.

  When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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